

PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1
 Stylesheet Version v1.2

EPAS ID: PAT6088102

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
CONVEYING PARTY DATA	
Name	Execution Date
HIROYUKI SAGAMI	11/12/2018
JUNPEI TERADA	11/20/2018
HIROSHI AIHARA	11/21/2018
TAKAYUKI MATSUO	11/21/2018
RECEIVING PARTY DATA	
Name:	DAIKIN INDUSTRIES, LTD.
Street Address:	UMEDA CENTER BUILDING, 4-12, NAKAZAKI-NISHI 2-CHOME, KITA-KU
City:	OSAKA-SHI, OSAKA
State/Country:	JAPAN
Postal Code:	530-8323
PROPERTY NUMBERS Total: 1	
Property Type	Number
Application Number:	16761007
CORRESPONDENCE DATA	
Fax Number:	(202)293-7860
<i>Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.</i>	
Phone:	202-293-7060
Email:	bbai@sughrue.com, sughrue@sughrue.com
Correspondent Name:	SUGHRUE MION, PLLC
Address Line 1:	2000 PENNSYLVANIA AVENUE, N.W.
Address Line 2:	SUITE 900
Address Line 4:	WASHINGTON, D.C. 20006
ATTORNEY DOCKET NUMBER:	Q254336
NAME OF SUBMITTER:	BETSY BAI, NEW APPLICATIONS SPECIALIST
SIGNATURE:	/Betsy Bai/
DATE SIGNED:	05/01/2020
This document serves as an Oath/Declaration (37 CFR 1.63).	
Total Attachments: 2	

source=Q254336CombinedAssignmentwithDeclarationExecuted#page1.tif

source=Q254336CombinedAssignmentwithDeclarationExecuted#page2.tif

PATENT
REEL: 052548 FRAME: 0994

NAME OF SOLE OR FIRST INVENTOR:	
Given Name (first and middle [if any])	Family Name or Surname
Hiroyuki	SAGAMI
Inventor's signature	Date
Hiroyuki Sagami	November, 12, 2018
Residence: Osaka-Shi, Osaka, JAPAN	
Mailing Address: c/o DAIKIN INDUSTRIES, LTD., Umeda Center Building, 4-12, Nakazaki-Nishi 2-Chome, Kita-ku, Osaka-Shi, Osaka, 530-8323, JAPAN	
NAME OF SECOND INVENTOR:	
Given Name (first and middle [if any])	Family Name or Surname
Junpei	TERADA
Inventor's signature	Date
Junpei Terada	November, 20, 2018
Residence: Osaka-Shi, Osaka, JAPAN	
Mailing Address: c/o DAIKIN INDUSTRIES, LTD., Umeda Center Building, 4-12, Nakazaki-Nishi 2-Chome, Kita-ku, Osaka-Shi, Osaka, 530-8323, JAPAN	
NAME OF THIRD INVENTOR:	
Given Name (first and middle [if any])	Family Name or Surname
Hiroshi	AIHARA
Inventor's signature	Date
Hiroshi Aihara	November, 21, 2018
Residence: Osaka-Shi, Osaka, JAPAN	
Mailing Address: c/o DAIKIN INDUSTRIES, LTD., Umeda Center Building, 4-12, Nakazaki-Nishi 2-Chome, Kita-ku, Osaka-Shi, Osaka, 530-8323, JAPAN	
NAME OF FOURTH INVENTOR:	
Given Name (first and middle [if any])	Family Name or Surname
Takayuki	MATSUO
Inventor's signature	Date
Takayuki Matsuo	November, 21, 2018
Residence: Osaka-Shi, Osaka, JAPAN	
Mailing Address: c/o DAIKIN INDUSTRIES, LTD., Umeda Center Building, 4-12, Nakazaki-Nishi 2-Chome, Kita-ku, Osaka-Shi, Osaka, 530-8323, JAPAN	